## POWER MANAGEMENT

## Features

■ Input Voltage - 4.75 V to 45 V

- Output Voltage - Up to 65 V
- Step-up (Boost) Controller
- Ultra-Fast Transient Response
- Programmable Switching Frequency
- External Sync Frequency for Boost Controller
- Linear Current Sinks
- 4 Strings, up to $150 \mathrm{~mA} /$ String
- Current Matching $\pm 1 \%$
- Current Accuracy $\pm 2 \%$
- PWM Dimming
- String-by-String Phase Shifting
- Dimming Frequency $100 \mathrm{~Hz}-30 \mathrm{kHz}$
- User Selectable 9 or 10 Bits Dimming Resolution
- Optional Synchronization to VSYNC/HSYNC Signal
- External Frequency Synchronization, FSYNC
- 8-bit Analog Dimming
- $1^{2} C$ Interface
- Fault Status - Open/Short LED, OTP
- Device Control: SYNC Freq, PLL Setting
- Protection Features
- Open/Shorted LED(s) and adjustable OVP
- Over-Temperature
- 4 mm X 4 mm 24 Ld QFN Package
- AEC-Q100 Qualified Version Available


## Applications

- Medium-sized LCD Panel
- Automotive Car Navigation/Information Display
- LCD Monitors
- Automotive AEC-Q100 Qualified Application


## Description

The SC5012/Q is a 4-channel high-precision, high-efficiency step-up (Boost) HB LED driver designed for backlight applications. It features wide input voltage range $(4.75 \mathrm{~V}$ to 45 V$)$, flexible output configuration, wide analog and PWM dimming range, phase shifting, optional fading, external boost controller frequency synchronization (FSYNC), $I^{2} \mathrm{C}$ interface, and numerous protection features.

The boost controller, with programmable switching frequency from 200 kHz to 2.2 MHz , can maximize efficiency by dynamically minimizing the output voltage while maintaining LED string current accuracy. It provides excellent line and load response with no external compensation components. Each linear current sink is matched within $\pm 1 \%$ for superb lighting uniformity, and the accuracy of each string current is $\pm 2 \%$. An external resistor adjusts the current from 40-150mA per string. It also features PWM dimming resolution of 9 or 10 bits (user selectable) over a dimming frequency from 100 Hz to 20 kHz , synchronized to the SYNC signal or the boost oscillator. String-by-string phase shifting reduces the demand on the input/output capacitance, decreases EMI, and improves dimming linearity.

SC5012/Q is available in $4 \mathrm{~mm} \times 4 \mathrm{~mm} 24$ Ld QFN package.
The SC5012Q is an AEC-Q100 qualified version.

## Typical Application Circuit



## Pin Configuration



## Ordering Information

| Device | Package |
| :---: | :---: |
| SC5012MLTRT $^{(1)(2)}$ | MLPQ-24 4×4 |
| SC5012QMLTRT $^{(1)(2)(3)}$ | MLPQ-24 4×4 |
| SC5012EVB | Evaluation Board |
| SC5012QEVB | Evaluation Board |

## Notes:

(1) Available in tape and reel only. A reel contains 3,000 devices.
(2) Lead-free packaging only. Device is WEEE and RoHS compliant, and halogen free.
(3) Device is AEC-Q100 qualified.

## Marking Information



$$
\begin{aligned}
& \text { nnnn }=\text { Part Number Code } \\
& \text { yyww }=\text { Datecode } \\
& \text { xxxxx }=\text { Semtech Lot No. } \\
& \text { xxxxx }=\text { Semtech Lot No. }
\end{aligned}
$$


nnnn = Part Number Code
yyww = Datecode
xxxxx = Semtech Lot No.
xxxxx = Semtech Lot No.

## Absolute Maximum Ratings

VCC, SYNC, FSYNC (V) . . . . . . . . . . . . . . . . . . . . . -0.3 to +6.0
EN(V) $\qquad$ -0.3 to VIN
VIN, IO1 to IO4(V)
-0.3 to +48
DRVN, OVP, CS, SS, SCP, VLDO, FLT (V) . . . . . . . - 0.3 to +6.0
FSET, CPLL, SCL, SDA, ISET, PWMI(V) . . . . . . . . - 0.3 to +6.0
PGND to AGND (V) . ............................ . 0.3 to +0.3
ESD Protection Level ${ }^{(1)}(\mathrm{kV})$ $\qquad$

## Recommended Operating Conditions

Ambient Temperature Range ( ${ }^{\circ} \mathrm{C}$ ) $\ldots \ldots . .-40 \leq \mathrm{T}_{\mathrm{A}} \leq+85$
VIN (V)
4.75 to 45

IO1 to IO4 Current per String (mA) $\ldots \ldots$...... up to 150

## Thermal Information

Thermal Resistance, Junction to Ambient ${ }^{(2)}\left({ }^{\circ} \mathrm{C} / \mathrm{W}\right)$... 30
Maximum Junction Temperature ( ${ }^{\circ} \mathrm{C}$ ) ............... +150
Storage Temperature Range ( ${ }^{\circ} \mathrm{C}$ ) $\ldots \ldots \ldots . . .-65$ to +150
Peak IR Reflow Temperature (10s to 30s) ( ${ }^{\circ} \mathrm{C}$ ) ...... +260

Exceeding the above specifications may result in permanent damage to the device or device malfunction. Operation outside of the parameters specified in the Electrical Characteristics section is not recommended.

## NOTES:

(1) Tested according to JEDEC standard JESD22-A114-B.
(2) Calculated from package in still air, mounted to $3 \times 4.5$ (in.), 4 layer FR4 PCB with thermal vias under the exposed pad per JESD51 standards.

## Electrical Characteristics

Unless noted otherwise, $T_{A}=25^{\circ} \mathrm{C}$ for typical, $-40^{\circ} \mathrm{C}<\mathrm{T}_{\mathrm{A}}<85^{\circ} \mathrm{C}$ for min and max. $\mathrm{V}_{\text {CC }}=5 \mathrm{~V}, \mathrm{R}_{\text {ISET }}=34 \mathrm{k} \Omega, \mathrm{R}_{\text {FSET }}=100 \mathrm{k} \Omega, \mathrm{V}_{\text {IN }}=12 \mathrm{~V}$.

| Parameter | Symbol | Conditions | Min | Typ | Max | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Input Supply |  |  |  |  |  |  |
| $\mathrm{V}_{\text {IN }}$ Supply Voltage | $\mathrm{V}_{\text {IN }}$ |  | 4.75 |  | 45 | V |
| $\mathrm{V}_{\text {IN }}$ Quiescent Supply Current | $\mathrm{I}_{\text {IN(Q) }}$ | EN = high, Switching, No Load |  | 2 |  | mA |
| $\mathrm{V}_{\text {IN }}$ Supply Current in Shutdown | $\mathrm{I}_{\mathrm{IN(SD)}}$ | $\mathrm{EN}=0, \mathrm{~V}_{\text {IN }}=12 \mathrm{~V}$ |  | 6 | 10 | $\mu \mathrm{A}$ |
|  |  | $\mathrm{EN}=0, \mathrm{~V}_{\text {IN }}=28 \mathrm{~V}$ |  | 14 | 25 | $\mu \mathrm{A}$ |
| $\mathrm{V}_{\text {cc }}$ Supply Voltage | $\mathrm{V}_{\text {cc }}$ |  | 4.5 |  | 5.5 | V |
| $\mathrm{V}_{\mathrm{cc}}$ Under-Voltage Lockout Threshold | $\mathrm{V}_{\text {cc-uvLo(TH) }}$ | $\mathrm{V}_{\text {cc }}$ Voltage Rising | 4.0 | 4.15 | 4.3 | V |
| $\mathrm{V}_{\mathrm{cc}}$ Under-Voltage Lockout Hysteresis | $\mathrm{V}_{\text {cc-uvio(HYS) }}$ | $\mathrm{V}_{\mathrm{cc}}$ Voltage Falling |  | 180 |  | mV |
| Linear Regulator (LDO) |  |  |  |  |  |  |
| VLDO Output Accuracy | $\mathrm{V}_{\text {LDo-AcC }}$ | LDO Load $=10 \mathrm{~mA}$ | 4.875 | 5 | 5.125 | V |
| VLDO Current Limit | $\mathrm{I}_{\text {LDo-LIMIT(ST) }}$ | During Start-up |  | 85 |  | mA |
|  | $\mathrm{I}_{\text {LDo-LIMIT(OP) }}$ | Operating Current Limit | 65 | 100 |  | mA |
| VLDO Droput Voltage | $\mathrm{V}_{\text {LDO- DROP }}$ | $\mathrm{V}_{\text {IN }}=4.75 \mathrm{~V}$, Load $=50 \mathrm{~mA}$ |  | 250 | 500 | mV |
| $\mathrm{V}_{\text {LDO }}$ Under-Voltage Lockout Threshold | $\mathrm{V}_{\text {LDo-uvio(th) }}$ | $\mathrm{V}_{\text {LDo }}$ Voltage Rising | 4.0 | 4.15 | 4.3 | V |

## Electrical Characteristics (continued)

| Parameter | Symbol | Conditions | Min | Typ | Max | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{V}_{\text {LDo }}$ Under-Voltage Lockout Hysteresis | $\mathrm{V}_{\text {LDo-uvio(HS) }}$ | $\mathrm{V}_{\text {LDo }}$ Voltage Falling |  | 180 |  | mV |
| External FET Gate Drive |  |  |  |  |  |  |
| DRVN High Level | $\mathrm{V}_{\text {DRVN(H) }}$ | 100mA from DRVN to GND | $\mathrm{V}_{\text {cc }}-0.5$ | $\mathrm{V}_{\text {cc }}-0.2$ |  | V |
| DRVN Low Level | $V_{\text {drVN(L) }}$ | -100mA from DRVN to $\mathrm{V}_{\mathrm{cc}}$ |  | 0.2 | 0.5 | V |
| DRVN On-Resistance | $\mathrm{R}_{\text {DRVN }}$ | DRVN high or Low |  | 1 | 3 | $\Omega$ |
| DRVN Sink Current | $\mathrm{I}_{\text {DRVN }}$ | DRVN forced to 2.5 V |  | 1.9 |  | A |
| DRVN Source Current | $\mathrm{I}_{\text {DRVN }}$ | DRVN forced to 2.5 V |  | 1.5 |  | A |
| Boost Converter |  |  |  |  |  |  |
| CS Current Limit Threshold | $\mathrm{V}_{\text {CSILIM }}$ |  | 0.36 | 0.40 | 0.44 | V |
| Internal Soft-start Time ${ }^{(1)}$ | $\mathrm{t}_{\text {ss }}$ | From EN to end of soft start, $\mathrm{F}_{\text {sw }}=1 \mathrm{MHz}$ |  | 4.4 |  | ms |
| External Soft-start Current | $\mathrm{I}_{\text {s }}$ |  |  | 10 |  | $\mu \mathrm{A}$ |
| Boost Oscillator Frequency | $\mathrm{F}_{\text {SW }}$ | $\mathrm{R}_{\text {FSET }}=100 \mathrm{k} \Omega$ | 0.95 | 1 | 1.05 | MHz |
| Boost Oscillator Frequency | $\mathrm{F}_{\text {osc }}$ | $\mathrm{R}_{\text {FSET }}$ Varies | 0.2 |  | 2.2 | MHz |
| Minimum duty cycle | $\mathrm{D}_{\text {MIN }}$ |  |  |  | 0 | \% |
| Maximum duty cycle | $\mathrm{D}_{\text {MAX }}$ |  | 85 | 90 |  | \% |
| FSYNC Input Frequency Range | $\mathrm{F}_{\text {FSYNC }}$ | SYNC Range From Boost Oscillator Frequency | -10 |  | +10 | \% |

## Control Signals: EN

| High Voltage Threshold | $\mathrm{V}_{\mathrm{EN}-\mathrm{H}}$ |  | 1.4 |  |  | V |
| :--- | :---: | :---: | :---: | :---: | :---: | :---: |
| Low Voltage Threshold | $\mathrm{V}_{\mathrm{EN}-\mathrm{LL}}$ |  |  |  | 0.4 | V |
| EN Leakage Current | $\mathrm{I}_{\mathrm{EN}-\mathrm{LEAK}}$ | $\mathrm{V}_{\mathrm{EN}}=\mathrm{VIN}=28 \mathrm{~V}$ |  | 11 | 18 | $\mu \mathrm{~A}$ |

## Control Signals: SYNC, SDA, SCL, FSYNC

| High Voltage Threshold | $\mathrm{V}_{\text {IH }}$ |  | 2.1 |  | V |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Low Voltage Threshold | $\mathrm{V}_{\text {IL }}$ |  |  | 0.8 | V |
| SDA Output Low | $\mathrm{V}_{\text {SDAL }}$ | -3 mA from $\mathrm{V}_{\text {cc }}$ to SDA |  | 0.4 | V |
| Pin Leakage Current | $\mathrm{I}_{\text {Leak }}$ | $\mathrm{V}_{\text {EN }}=0 \mathrm{~V}, \mathrm{~V}_{\text {SYNC }}=\mathrm{V}_{\text {SDA }}=\mathrm{V}_{\text {SDL }}=\mathrm{V}_{\text {FSYNC }}=5.0 \mathrm{~V}$ | -1 | 1 | $\mu \mathrm{A}$ |
| Control Signals: PWMI |  |  |  |  |  |
| High Voltage Threshold | $\mathrm{V}_{\text {PWMM-H }}$ |  | 2.1 |  | V |

## Electrical Characteristics (continued)

| Parameter | Symbol | Conditions | Min | Typ | Max | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Low Voltage Threshold | $\mathrm{V}_{\text {PWM-HL }}$ |  |  |  | 0.8 | V |
| Pin Leakage Current | $\mathrm{I}_{\text {PWMILLEAK }}$ | $\mathrm{V}_{\text {EN }}=5 \mathrm{~V}=\mathrm{V}_{\text {PWMI }}$ | -1 |  | 1 | $\mu \mathrm{A}$ |
|  |  | $\mathrm{V}_{\mathrm{EN}}=0 \mathrm{~V}, \mathrm{~V}_{\text {PWMI }}=5 \mathrm{~V}$ |  | 200 |  | $\mu \mathrm{A}$ |
| PWM Dimming |  |  |  |  |  |  |
| PWMI Input Dimming Frequency ${ }^{(1)}$ | $\mathrm{F}_{\text {PWMI }}$ |  | 100 |  | 30k | Hz |
| IOx Dimming Minimum Pulse Width | $\mathrm{T}_{\text {PWM(MIN) }}$ | $F_{\text {PWM(LED) }}=100 \mathrm{~Hz}-30 \mathrm{kHz}$ |  | 300 |  | ns |
| SYNC Input Frequency | $\mathrm{F}_{\text {SYNC }}$ |  | 30 |  | 100k | Hz |
| PWMI Input Resolution |  | $100 \mathrm{~Hz}<\mathrm{F}_{\text {PWMI }}<10 \mathrm{kHz}$ |  | 10 |  | bits |
|  |  | $10 \mathrm{kHz}<\mathrm{F}_{\text {PWMI }}<30 \mathrm{kHz}$ |  | 9 |  | bits |
| Over-Voltage Protection |  |  |  |  |  |  |
| OVP Trip Threshold Voltage | $\mathrm{V}_{\text {ovp(TRIG) }}$ | OVP Rising | 1.17 | 1.22 | 1.27 | V |
| OVP Hysteresis | $\mathrm{V}_{\text {OVP(HYS) }}$ | OVP Falling |  | 10 |  | mV |
| OVP Leakage Current | $\mathrm{I}_{\text {ovp(LEAK }}$ | $\mathrm{OVP}=5 \mathrm{~V}$ |  | 0.1 | 1 | $\mu \mathrm{A}$ |
| Current Sink (IO1 to IO4) |  |  |  |  |  |  |
| ISET pin voltage | $V_{\text {ISET }}$ |  |  | 1.23 |  | V |
| Regulation Voltage | $\mathrm{V}_{\text {IOn(REG) }}$ | Voltage of Regulating String |  | 0.8 |  | V |
| Current Sink Disable Threshold | $\mathrm{V}_{10 \mathrm{O}(\mathrm{DIS})}$ | Checked at Power-up | 0.6 |  |  | V |
| Current Sink Rise/Fall Time ${ }^{(1)}$ | $\mathrm{t}_{\text {RISE/FALL }}$ | Rising edge from $10 \%$ to $90 \%$ of $\mathrm{I}_{\text {(n) }}$ |  | 25 |  | ns |
| LED Current Accuracy | $\mathrm{I}_{\text {On(ACC\% }}$ | $\mathrm{PWMI}=100 \%, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ | 147 | 150 | 153 | mA |
|  |  | PWMI $=100 \%, \mathrm{~T}_{\mathrm{A}}=-40^{\circ} \mathrm{C} \sim 85^{\circ} \mathrm{C}$ | 144 | 150 | 156 | mA |
| LED Current Matching ${ }^{(2)}$ | IOn (MATCH) | PWMI $=100 \% ; \mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ |  |  | $\pm 1$ | \% |
|  |  | PWMI $=100 \% ; \mathrm{T}_{\mathrm{A}}=-40^{\circ} \mathrm{C} \sim 85^{\circ} \mathrm{C}$ |  |  | $\pm 3$ | \% |
| $\mathrm{I}_{\text {On }}$ Off Leakage Current | $\mathrm{I}_{\text {On(LEAK) }}$ | PWMI $=0 \mathrm{~V}, \mathrm{EN}=0 \mathrm{~V}, \mathrm{~V}_{101} \sim \mathrm{~V}_{104}=25 \mathrm{~V}$ |  | 0.1 | 1 | $\mu \mathrm{A}$ |
| Phase Delay Time (IO1 to IO4) | $\mathrm{t}_{\text {PD }}$ | FAST_FREQ = 1 (Default Setting) $\mathrm{t}_{\mathrm{PD}}=(1 / 4)^{*}\left(1 / \mathrm{F}_{\text {PWM(IO) }}\right), 4$ Strings On |  | 11.6 |  | $\mu \mathrm{s}$ |

## Electrical Characteristics (continued)

| Parameter | Symbol | Conditions | Min | Typ | Max | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| PWM Output Resolution |  | $\mathrm{F}_{\text {PWM(10) }}=10 \mathrm{kHz}$ |  | 10 |  |  |
|  |  | $\mathrm{F}_{\text {PWM(10) }}=20 \mathrm{kHz}$ |  | 9 |  |  |
| IO Switching Frequency | $\mathrm{F}_{\text {PWM(10) }}$ | FAST_FREQ $=0$ |  | 10.75 |  | kHz |
|  |  | FAST_FREQ = 1 (Default Setting) |  | 21.50 |  |  |
| Fault Protection |  |  |  |  |  |  |
| LED Short Circuit Protection Threshold | $\mathrm{V}_{10 \mathrm{O}(\mathrm{SCP})}$ | $\mathrm{R}_{4}$ and $\mathrm{R}_{5}{ }^{(3)}$ | 8.5 xV SCP | $10 \times \mathrm{V}_{\text {SCP }}$ | $11.5 \mathrm{xV} \mathrm{V}_{\text {SCP }}$ | V |
| LED Open Circuit Protection Threshold | $\mathrm{V}_{10 \_ \text {OCP }}$ | $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ |  | 0.2 |  | V |
| LED Short Circuit Fault Delay | $\mathrm{t}_{\text {SCP(DELAY) }}$ | $\mathrm{V}_{\text {ovp }}$ set to $1.5 \mathrm{~V}, \overline{\mathrm{FLT}}$ goes low |  | 1 |  | $\mu \mathrm{s}$ |
|  |  | PWM dimming |  | 10 |  | $\mu s$ |
| $\overline{\text { FLT Pin Leakage Current }}$ | $\left.\right\|_{\text {FITİLEAK }}$ | $\mathrm{V}_{\mathrm{EN}}=0 \mathrm{~V}, \mathrm{~V}_{\overline{\mathrm{FLT}}}=\mathrm{VLDO}$ | -1 |  | 1 | $\mu \mathrm{A}$ |
| $\overline{\text { FLT Output Low }}$ | $\mathrm{V}_{\overline{\text { FLT(LIOW }} \text { ) }}$ | -5 mA from $\overline{\mathrm{FLT}}$ |  |  | 0.5 | V |

## Over-Temperature Protection

| Thermal Shutdown Temperature | $\mathrm{T}_{\text {отр }}$ |  |  | 150 |  | ${ }^{\circ} \mathrm{C}$ |
| :--- | :---: | :---: | :---: | :---: | :---: | :---: |
| Thermal Shutdown Hysteresis | $\mathrm{T}_{\text {отр_Hצs }}$ |  |  | 10 |  | ${ }^{\circ} \mathrm{C}$ |

## $I^{2}$ C Control Interface: SDA, SCL Timing Specifications

| SCL Clock Frequency | $\mathrm{F}_{\mathrm{SCL}}$ |  |  |  | 400 | kHz |
| :--- | :---: | :--- | :--- | :--- | :---: | :---: |
| SCL Clock Low Period | $\mathrm{t}_{\text {LOW(SCL) }}$ |  | 1.3 |  |  | $\mu \mathrm{~s}$ |
| SCL Clock High Period | $\mathrm{t}_{\text {HIGH(SCL) }}$ |  | 0.6 |  |  | $\mu \mathrm{~s}$ |
| Hold Time Start Condition | $\mathrm{t}_{\text {HD(START) }}$ |  | 0.6 |  |  | $\mu \mathrm{~s}$ |
| SDA Setup Time | $\mathrm{t}_{\text {SU(SDA) }}$ |  | 100 |  |  | ns |
| SDA Hold Time | $\mathrm{t}_{\text {HD(SDA) }}$ |  | 0 |  | 0.9 | $\mu \mathrm{~s}$ |
| Setup Time Stop Condition | $\mathrm{t}_{\text {SU(STOP) }}$ |  | 0.6 |  |  | $\mu \mathrm{~m}$ |
| Bus Free Time between Stop \& Start | $\mathrm{t}_{\mathrm{BF}}$ |  | 1.3 |  |  | $\mu \mathrm{~s}$ |

## Notes:

(1) Ensured by design and characterization, not production tested.
(2) LED current matching for 4 channels is defined as the largest of the two numbers, i.e., (MAX-AVG)/AVG and (AVG-MIN)/AVG; where MAX is the maximum LED channel current, MIN is the minimum LED channel current and AVG is the average of the 4 LED channel currents.
(3) Refer to the application circuit on page26, Figure 2.

## Typical Characteristics

Backlight Efficiency vs. Input Voltage


Backlight Efficiency vs. LED String Current


PWM Dimming Linearity with Phase Shift


Backlight Efficiency vs. Input Voltage


Backlight Efficiency vs. LED String Current


PWM Dimming Linearity with Phase Shift


## Typical Characteristics (continued)

LED String Current Matching vs. Temperature


Switching Frequency vs. $\mathrm{R}_{\text {FSET }}$


LED String Current vs. Analog Dimming Control Register (IDAC) Value


LED String Current vs. $\mathrm{R}_{\text {ISET }}$


LED String Current Accuracy vs Temperature


## Typical Characteristics (continued)



Start-up Into Short Circuit Protection


Synchronization of Switching Frequency

Unused String
$150 \mathrm{~mA} / \mathrm{CH}, \mathrm{CH} 4$ short to ground


Start-up Into Open Circuit Protection 4P10S, 150mA/CH, CH4 Open


Time (20ms/div)
Synchronization of LED Dimming Frequency SYNC= 21 KHz


Time (20us/div)

## Typical Characteristics (continued)

Fade In/Out (Logarithmic)


Line Transient Response


Load Transient Response
$\operatorname{PWMI}(20 \mathrm{KHz})=0.5 \%$ to $99 \%, \mathrm{VIN}=12 \mathrm{~V}, 150 \mathrm{~mA} / \mathrm{CH}$ X 4 Fading disabled


Fade In/Out (Linear)


Line Transient Response


Load Transient Response
$\operatorname{PWMI}(20 \mathrm{KHz})=99 \%$ to $0.5 \%, \mathrm{VIN}=12 \mathrm{~V}, 150 \mathrm{~mA} / \mathrm{CH}$ X 4


## Typical Characteristics (continued)

LED Dimming Without Phase Shift
$10 \%$ dimming $@ 20 \mathrm{KHz}, \mathrm{V}_{\mathrm{w}}=12 \mathrm{~V}, 4 \mathrm{PP} 10 \mathrm{~S}, 150 \mathrm{~mA} / \mathrm{CH}$


LED Dimming Without Phase Shift


Time (20us/div)
Analog Dimming Transient via $I^{2} \mathrm{C}$ $0.39 \%$ to $100 \%$ dimming duty


Time (100us/div)


LED Dimming With Phase Shift


Analog Dimming Transient via $I^{2} \mathrm{C}$


## Pin Descriptions

| $\begin{aligned} & \text { Pin \# } \\ & \text { (QFN) } \end{aligned}$ | Pin Name | Pin Function |
| :---: | :---: | :---: |
| 1 | CPLL | Compensation for the internal PLL - Connect a compensation resistor and capacitor from this pin to analog ground. This pin can be left floating if not used. |
| 2 | SYNC | SYNC input pin — Feeding the SYNC signal 30 Hz to 100 KHz to this input results in internal PLL being synchronized to the SYNC signal. This pin can be left floating if not used. |
| 3 | SCL | $1^{12} \mathrm{C}$ serial clock input - This pin must be connected to ground if not used. |
| 4 | SDA | $1^{2} \mathrm{C}$ serial data input - This pin must be connected to ground if not used. |
| 5 | ISET | LED current programming pin - Connect an external resistor to analog ground to program the peak current in the LED strings. For more details please refer to LED String Peak Current Programming on page 16. |
| 6 | $\overline{\text { FLT }}$ | Logic low fault status pin - Open-drain output is latched low when fault condition is detected: Open/Short LED, Shorted String, OVP or OTP. Fault status can be reset by removing fault condition(s) and toggling the EN or VCC pin. This pin can be left floating if not used. |
| 7 | PWMI | LED string PWM dimming control input. |
| 8 | 101 | Regulated current sink LED channel 1 - Connect this pin to the cathode of the bottom LED in string 1. Connect pin to ground to disable this LED string during power on. |
| 9 | 102 | Regulated current sink LED channel 2 - Connect this pin to the cathode of the bottom LED in string 2. Connect pin to ground to disable this LED string during power on. |
| 10 | 103 | Regulated current sink LED channel 3 - Connect this pin to the cathode of the bottom LED in string 3. Connect pin to ground to disable this LED string during power on. |
| 11 | 104 | Regulated current sink LED channel 4 - Connect this pin to the cathode of the bottom LED in string 4. Connect pin to ground to disable this LED string during power on. |
| 12 | OVP | Over-voltage feedback pin — Over-voltage activated when pin exceeds 1.22 V . Use a resistor divider tied to the output and analog ground to set the OVP level. |
| 13 | EN | Enable pin - Pull high to enable the device or pull low to disable and maintain low shutdown current. |
| 14 | SCP | Short circuit LED protection programming pin — Shorted LED protection disables the individual channel when the current sink voltage exceeds the programmed voltage threshold. Adding a resistor divider from this pin to VLDO and AGND programs the shorted-LED protection up to $10 x$ the $\mathrm{V}_{\text {SCP }}$ voltage. Pulling the pin high disables the SCP feature on all channels. |
| 15 | SS | Soft-start pin - Connect a capacitor from this pin to analog ground. |
| 16 | CS | Step-up (boost) switch current sense pin — Connect a resistor from this pin to ground for current sense - utilized in peak current mode control loop and over-current sense circuitry. |
| 17 | PGND | Power ground - Tie this pin to the power ground plane close to input and output decoupling capacitors. |
| 18 | DRVN | Gate drive is connected to external step-up (boost) N-channel MOSFET. |

## Pin Descriptions (continued)

| Pin\# <br> (QFN) | Pin <br> Name | Pin Function |
| :---: | :---: | :--- |
| 19 | VCC | Input bias voltage supply for the gate drive circuitry - Accepts 4.5-5.5V inputs. Add a $1 \mu \mathrm{~F}$ or larger ceramic bypass <br> capacitor from this pin to ground. |
| 20 | VLDO | On-chip 5V LDO output. A capacitor should be connected from this pin to analog ground. |
| 21 | VIN | Connect to the input power supply - Accepts 4.75V - 45V input. Usually add $2.2 \mu \mathrm{~F}$ or larger ceramic bypass capaci- <br> tor from this pin to analog ground. |
| 22 | FSET | Step-up (boost) frequency set pin. - Connect a resistor from this pin to analog ground to set the frequency from <br> 200kHz to 2.2MHz. |
| 23 | AGND | Analog ground pin - Tie this pin to analog (quiet) ground isolated from step-up (boost) converter switching current <br> path. |
| 24 | FSYNC | External clock synchronization pin - With an applied external clock signal, the boost converter will be synchronized <br> with the rising edge of the external clock signal. |
| - | AGND | AGND thermal pad for heatsinking purposes - It should be connected to ground plane for proper circuit operation. |

## Block Diagram



## Start-up Timing Diagram



## Applications Information

## General Description

The SC5012/Q contains a high frequency, current-mode, internally compensated boost controller and four constant current sinks for driving LED strings. The LED peak current for all strings is programmed by an external resistor. The boost converter operates to maintain minimal required output voltage for regulating the LED current to the programmed value. A typical backlight application uses 3 to 14 LEDs per string, with current driven up to 150 mA . The unique control loop of the SC5012/Q allows fast transient response in dealing with line and load disturbances. The SC5012/Q, operating with an external Power MOSFET, regulates the boost converter output voltage based on the instantaneous requirement of the 4 string current sources. This provides power to the entire lighting subsystem with increased efficiency and reduced component count. It supports PWM dimming frequencies from 100 Hz to 30 kHz and the supply current is reduced to 2 mA typical when all LED strings are off. An external FSYNC pin provides the flexibility to apply an external clock signal to synchronize the boost converter switching.

## Start-Up

When the EN pin is pulled high ( $>1.4 \mathrm{~V}$ ), the device is enabled and the internal 5 V regulator output, VLDO, starts to turn on. VLDO powers most of the internal circuitry in the SC5012/Q, while the VCC input powers only the gate drive circuitry for DRVN. VCC is normally connected externally to VLDO through an RC filter, but can also be driven from a separate 5 V power supply. VLDO and VCC have a fixed under-voltage rising and falling trip point and when both are higher than the UVLO threshold of 4.15 V (typical), the SC5012/Q goes into a start-up sequence.

In this next phase, the SC5012/Q checks each IO pin to determine if the respective LED string is enabled. Each IO pin is pulled up with a 100 uA current source and if any IO pin is connected to ground, it will be detected as unused and turned off. The unused string checking procedure typically takes 1 mS and after this the SC5012/Q enters into a soft-start sequence.

The SC5012/Q has a fixed internal and programmable external soft-start function, where the slower of the two dominates. The soft-start function helps to prevent excess inrush current through the input rail during start-up. In the SC5012/Q, the soft-start is implemented by slowly ramping up the reference voltage fed to the error ampli-
fier. This closed loop start-up method allows the output voltage to ramp up without any overshoot. The duration of the internal soft-start is controlled by an internal timing circuit, which is used during start-up and is based on the boost converter switching frequency. For example, with the switching frequency at 1 MHz , it is 4 mS typical and becomes 2 mS typical when the switching frequency is 2 MHz . For longer soft-start times an external capacitor can be placed from the SS pin to ground. A 10uA charging current flows from the SS pin through the external capacitor which sets the soft-start duration.

$$
\mathrm{T}_{\mathrm{ss}}=\frac{C_{22} * \Delta V_{22}}{10 u A}
$$

If the PWM voltage goes low while the SC5012/Q is in soft-start operation, the SC5012/Q switches to standby mode, where the external power MOSFET and the LED current sources will be turned off immediately. The softstart timers are turned off and the soft-start value is saved. When the PWM voltage goes high again, the softstart resumes from the previously saved value.

Each LED current source (IO1 to IO4) tries to regulate the LED current to its set point. The control loop will regulate the output voltage such that all the IO pin voltages are at least 0.8 V typical.

## Shutdown

When the EN pin is pulled down below 0.4 V , the device enters into shutdown mode. In this mode, all the internal circuitry is turned off and the supply current drops to $14 \mu \mathrm{~A}$ typical.

In the scenario where the EN pin voltage is high, but either VLDO or VCC voltage falls below its respective UVLO threshold, the SC5012/Q goes into a suspend mode. In this mode, all the internal circuitry except the reference and the oscillator are turned off.

## Thermal Shutdown (TSD)

If the thermal shutdown temperature of typical $150^{\circ} \mathrm{C}$ is reached, the boost converter and all IO current sources are turned off. The $\overline{\text { FLT }}$ pin is forced low in this condition. When the temperature falls below the TSD trip point by $10^{\circ} \mathrm{C}$, the SC5012/Q will restart following the start-up sequence as described before. The $\overline{\mathrm{FLT}}$ pin is latched and will stay low, it is reset by cycling the EN or VCC.

## Applications Information (continued)

## Boost Converter Operation

The SC5012/Q includes a boost controller with programmable switching frequency. It applies a current-mode control method with an integrated compensation loop as shown in the diagram below. The clock (see block diagram on page 14) from the oscillator sets the latch and turns on the external power MOSFET, which serves as the main power switch. The current flowing through this switch is sensed by the current sense resistor in series with the switch. The sensed switch current is summed with the slope-compensated ramp and fed into the modulating input of the PWM comparator. When the modulating ramp intersects the error amplifier output (COMP), the latch is reset and the power MOSFET is turned off. The sense resistor also sets the peak current limit of the power MOSFET, I ${ }_{\text {OCP }}$ using the following equation:


The current-mode control system contains two loops. For the inner current loop, the error amplifier (EA) output (COMP) controls the peak inductor current. In the outer loop, the EA regulates the output voltage for driving the LED strings.

## Boost Converter Switching Frequency Selection

The resistor between FSET and GND sets the boost converter switching frequency ( 200 kHz to 2.2 MHz ) using the following equation:

$$
\mathrm{f}_{\mathrm{Sw}}[\mathrm{kHz}]=10^{5} / \mathrm{R}_{\text {FSET }}[\mathrm{k} \Omega]
$$

A higher switching frequency allows the use of low-profile height inductors for space-constrained and cost-sensitive applications.

## FSYNC

The FSYNC function can be used to synchronize the boost switching frequency to an external clock signal applied to the FSYNC pin. The FSYNC frequency range is +/- $10 \%$ of the free running frequency set by the FSET pin, with the rising edge of DRVN being synchronized with the rising edge of FSYNC.

## Over-Voltage Protection (OVP)

SC5012/Q features programmable output over-voltage protection to prevent damage to the IC and output capacitor in the event of a LED string open-circuit. The boost converter output voltage is sensed at the OVP pin through the resistor voltage divider. The OVP trip threshold (refer to detailed application circuit) can be calculated using the following equation.

$$
\text { Output OVP Trip Voltage }[\mathrm{V}]=1.22 \mathrm{X}\left(\mathrm{R}_{11}+\mathrm{R}_{10}\right) / \mathrm{R}_{10}
$$

When the OVP pin voltage exceeds 1.22 V , the boost converter turns off and the $\overline{\text { FLT }}$ pin is pulled low. When the OVP pin voltage falls below the OVP threshold, the boost converter restarts and the $\overline{\mathrm{FLT}}$ pin is released.

There is 10 mV hysteresis between OVP pin threshold (falling) and OVP pin threshold (rising). This results in an output voltage hysteresis given by:

$$
\text { Output OVP Hysteresis[mV] = } 10 \mathrm{X}\left(\mathrm{R}_{11}+\mathrm{R}_{10}\right) / \mathrm{R}_{10}
$$

## LED Current Sink

The SC5012/Q provides 4 current sinks and each can sink up to 150 mA current. It incorporates LED string shortcircuit protection (trip-level programmable; can be disabled) and LED string open-circuit protection..

## LED String Peak Current Programming

LED string peak current (at 100\% dimming) can be set by selecting resistor $\mathrm{R}_{\text {ISET }}$, connected between ISET and GND. The relationship between $\mathrm{R}_{\text {ISET }}$ resistance and single LED string peak current is calculated using the following equation:

## Applications Information (continued)

$$
\mathrm{I}_{\text {LeD }}[\mathrm{mA}]=(4146 \times 1.23) / \mathrm{R}_{\text {ISET }}[\mathrm{k} \Omega]
$$

The LED string current can be programmed up to 150 mA .

## Unused Strings

The SC5012/Q may be operated with less than 4 strings. In this mode of operation, all unused IO pins should be connected to ground. During start-up, these unused strings are detected and disabled while other active strings work normally, and $\overline{\text { FLT }}$ does not be pulled low.

## LED Short-Circuit Protection (SCP)

The SC5012/Q features a programmable LED short-circuit protection (SCP). This allows the part to be customized based on the LED forward voltage (VF) mismatches between the LED strings. If one or more LEDs are detected as shortcircuited, the corresponding string will be latched off. The voltages on all IO pins are monitored to check if any IO pin exceeds the SCP trip point. The IO voltage for LED string(s) with faulty short-circuit LED(s) will be higher than other normal IO pin voltages. This LED short-circuit protection trip level (see detailed application circuit on page 26, Figure 2) is expressed by the following equation:

$$
\mathrm{V}_{\text {SCP_Trip } \left.[\mathrm{V}]=10 \times\left(\mathrm{VLDO} \times \mathrm{R}_{4}\right) /\left(\mathrm{R}_{4}+\mathrm{R}_{5}\right) .{ }^{2}\right)}
$$

If any IO pin voltage exceeds the trip voltage, the IO current sink will be latched off and the $\overline{\text { FLT }}$ will go low. This latch can be reset by cycling VCC or EN. Other LED strings are unaffected and continue in normal operation. This protection will be disabled if SCP is pulled to high.

There is a typical $10 \mu \mathrm{~s}$ SCP detection time in PWM dimming applications. If the PWM dimming on-time is less than the SCP detection time, the SCP cannot be enabled.

In many applications, LED strings are connected to the IO pins through a mechanical connector, which cannot support an electrical connection at specific times. This connection might cause noise on the IO pins. If this noise is large enough, it may trigger a false SCP mode. Under such condition, a ceramic decoupling capacitor ( $100 \mathrm{pF} \sim 8.2 \mathrm{nF}$ ) between IO pin to ground can help prevent the SC5012/Q from entering the protection mode by false trigger. Or, simply disable this feature by connecting SCP pin to VLDO pin.


Figure 1- $I^{2} C$ Control Method

## Applications Information (continued)

## LED Open-Circuit Protection

If any LED string becomes open, the respective IO pin voltage will be pulled to GND. Consequently, the internal COMP node (output of error amplifier) is driven high, which causes the boost output voltage to increase. The output voltage will be eventually clamped to a voltage set by the OVP resistor divider. Under this condition, the faulty string is latched off and the $\overline{\text { FLT }}$ pin is pulled low. The boost voltage gets regulated to the voltage required to set all non-faulty 10 pins above 0.8 V . The remaining strings remain in normal operation. The $\overline{\text { FLT }}$ and the fault-out LED current sink latch-off can be reset by cycling VCC or EN.

## LED Analog Dimming Control

The LED current in SC5012/Q can be dimmed via the 8-bit analog dimming register (register address: $0 \times 02$ ). The LED current can be adjusted in 256 steps from 0 mA to maximum value, which is determined by the $\mathrm{R}_{\text {ISET }}$ resistor.

The SC5012/Q has a unique DAC architecture which allows it to have excellent LED current accuracy and string-tostring matching over the entire DAC range.

The analog dimming method can be used in conjunction with PWM dimming to increase the dimming resolution. The fast loop response of the SC5012/Q allows the LED current to transition to a new value within $160 \mu \mathrm{~s}$ or so. Please refer to the graphs in the typical characteristics section.

## LED PWM Dimming Control

The SC5012/Q supports three PWM dimming modes for controlling the brightness of the LEDs.

The dimming modes are:
(1) PWM direct,
(2) PWM indirect and
(3) $I^{2} C$ control

It provides flexibility in setting the duty cycle and frequency of the LED PWM signal. The PWM dimming mode is set through the device control register (register address: $0 \times 01$ ) DCR [1:0] bits. Refer to Table 1 for more details.

## (1) PWM Direct Control

The PWM input needs to be held high for normal operation. PWM dimming can be achieved by cycling the PWM input at a given frequency where a "low" on the PWM input turns off all IO current sinks and a "high" turns on all IO current sinks. The PWM pin can be toggled by external circuitry to allow PWM dimming. In a typical application, a microcontroller sets a register or counter that varies the pulse width on a GPIO pin. The SC5012/Q allows dimming over a wide frequency range ( $100 \mathrm{~Hz}-30 \mathrm{kHz}$ ) in order to allow compatibility with a wide range of devices. This includes the newest dimming strategies that avoid the audio band by using high frequency PWM dimming. In this manner, a wide range of illumination can be generated while keeping the instantaneous LED current at its peak value for high efficiency and color temperature. The

Table 1 - Led Dimming Control Methods

| PWM Dimming Mode | Register Settings DCR[1:0] | PWM <br> Input <br> Source | LED PWM Output |  | Phase Shift Option |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | PWM Frequency | PWM Duty Cycle |  |
| PWM Direct Control | 00 | PWMI Pin Input | Same as the PWMI input (Range 100 Hz to 30 kHz | Same as the PWMI input | NO |
| PWM Indirect Control (Default Option) | 01 | PWMI Pin Input | Set via the FREQ Register ( $0 \times 05$ ) and FAST_FREQ bit 10 kHz (max): FAST_FREQ=0 20kHz(max): FAST_FREQ=1 | Same as the duty cycle of the PWMI input | YES |
| $1^{2} \mathrm{C}$ Control | 11 | $\begin{gathered} 1^{2} \mathrm{C} \\ \text { Control } \end{gathered}$ | Set via the FREQ Register (0x05) and FAST_FREQ bit 10 kHz (max): FAST_FREQ=0 20kHz(max): FAST_FREQ=1 | Set via the Duty Cycle Control <br> Register ( $0 \times 03,0 \times 04$ ) <br> 10 bits @ 10kHz output <br> 9 bits @ 20kHz output | YES |

## Applications Information (continued)

SC5012/Q provides a 1000:1 dimming range at 1 kHz PWM frequency. The LED current sinks turn on/off very rapidly (<25ns, typical). This allows a wide dimming ratio. An additional advantage of PWM dimming is that it avoids inrush currents when filling the boost output capacitor. Simply apply the PWM signal to the device at $10 \%$ duty for a millisecond or two, and in-rush current is reduced. This dimming time will vary based on the number of LEDs and the size of the output capacitor. This can be easily determined during testing and programmed into the microcontroller firmware.

## (2) PWM Indirect Control

This is the default mode for LED PWM dimming in the SC5012/Q. In this mode, the input signal applied on the PWM pin is passed through a duty cycle extractor block after the system has detected two successive duty cycles that are the same. The extractor measures the duty cycle of the PWM input, and, depending on the value of FAST_FREQ, the duty cycle is converted to a 9 -bit value (FAST_FREQ = 1) or a 10 -bit value (FAST_FREQ $=0$ ). This value is then passed to the PWM generator block as shown in Figure 1.

The LED PWM output frequency is set via the FREQ register (address 0x05) and the FAST_FREQ bit.

With FAST_FREQ $=0$, low dimming frequency option is selected and the PWM dimming frequency will be according to the following equation:

$$
\begin{aligned}
\text { PWM Dimming Frequency } & =\frac{11 \mathrm{MHz}}{1024 \times[\text { FREQ }[7: 0]+1]} \\
& =10.75 \mathrm{kHz}(\max )
\end{aligned}
$$

With FAST_FREQ $=1$, the high dimming frequency option is selected and the PWM dimming frequency is shown by the following equation:

$$
\begin{aligned}
\text { PWMDimmingFrequency } & =\frac{11 \mathrm{MHz}}{512 \times[\text { FREQ }[7: 0]+1]} \\
& =21.5 \mathrm{kHz}(\mathrm{max})
\end{aligned}
$$

The default option is FAST_FREQ $=1$. This gives 9-bit duty cycle resolution and up to 21.5 kHz dimming frequency range. The PWM input is usually generated by the system graphics processor. This mode allows the user to set the PWM output dimming frequency independent of the PWMI input.

If the PWM signal has jitter, the SC5012/Q provides an option to filter it out. Hysteresis is also provided by selecting the WND[1:0] bits in the DCR register (address $0 \times 01$ ). WND[1:0] bits set the window comparator such that if a change in the duty cycle is detected which is smaller than the set window, then it is ignored.

## (3) $I^{2} C$ Control

In $I^{2} \mathrm{C}$ dimming mode (refer to Figure 1, page 17), both the output LED dimming duty cycle and the dimming frequency are set via the internal registers. The PWMI pin should be connected to ground. In this mode, the LED dimming duty cycle is set via the duty cycle registers (addresses $0 \times 03,0 \times 04$ ); and the dimming frequency is set via the FREQ register (address $0 \times 05$ ) and the FAST_FREQ bit.

With FAST_FREQ $=0$, the LED duty cycle can achieve 10-bit resolution, $D[9: 0]$, which is combined by two portions: (1) MSB portion - register address $0 \times 03$ [1:0] and (2) LSB portion - register address $0 \times 04$ [7:0] as shown below.


The dimming duty cycle with FAST_FREQ $=0$ can be calculated as:

$$
\text { LED Dimming Duty Cycle }=\left\{\mathrm{D}[9: 0]_{\text {decimal }}\right\} / 2^{10-1}
$$

With FAST_FREQ = 1, the LED duty cycle can achieve 9-bit resolution, $\mathrm{D}[9: 1]$, which is combined by two portions: (1) MSB portion - register address $0 \times 03$ [1:0] and (2) LSB portion - register address $0 \times 04$ [7:1] as shown below.


## Components Selection

The dimming duty cycle with FAST_FREQ = 1 can be calculated as:

$$
\text { LED Dimming Duty Cycle }=\left\{\mathrm{D}[9: 1]_{\text {decimal }}\right\} / 2^{9}-1
$$

In both cases mentioned above, the duty cycle is fixed to be 0 when $D[9: 0]$ is set as $0 \times 00$.

The PWM dimming frequency is controlled the same way as in "Indirect Control".

## Phase-Shift PWM Dimming

The SC5012/Q provides an option for phase-shifted LED PWM dimming. This option is available in both PWMI indirect control and $I^{2} \mathrm{C}$ control. The phase-shift option is set by the PHASE_SHIFT bit in the Device Control Register (register address $0 \times 01$ ). This option delays the turn-on of the LED strings based on the number of the strings in operation (the number of the strings in operation is determined during the start-up). The delay time can be calculated by the following equation:

$$
\begin{aligned}
& \mathrm{T}_{\phi \text {-phase }}=\frac{1 / \mathrm{f}_{\mathrm{PWM}}}{\mathrm{~N}}, \\
& \mathrm{~N}=\text { number of strings in operation } \\
& \mathrm{f}_{\text {PWM }}=\text { LED PWM dimming frequency }
\end{aligned}
$$

Phase-shift mode is disabled during the soft-start period. This allows the output to ramp up to the correct voltage in a controlled fashion.

Phase-shifting reduces the peak input current, decreases EMI and improves the dimming linearity. The figures in the Typical Characteristics Section on page 7 show the improvement in dimming linearity with phase-shifted versus non-phase-shifted dimming.

## Backlight Fade-in and Fade-out Options

The SC5012/Q features an option for fade-in and fade-out brightness control, which allows a smooth transition from one brightness level to another.

Registers associated with these fading functions are shown in this section.

1. Fade Option (register address $0 \times 09$ ) - sets fade enable options, fade time, fade type.
2. Fade Rate (register address $0 \times 0 \mathrm{~A}$ ) - sets fade step size option.

The fade option register allows the user to select fading, choose between linear or logarithmic fading, and to set the fading time. The default setting is fading enabled with logarithmic mode. The fading time is determined by the LED PWM dimming frequency. The fade setting is shown in Table 2.

An example for calculating the linear fading time is shown in this section. Assuming LED PWM dimming frequency is 10 kHz , then 10 -bits are assigned for 1024 duty cycle settings.

Table 2 - Fade Setting

| Duty <br> Cycle <br> Zone | Duty Cycle <br> Range | Step <br> Increment | Step <br> Interval | Total Steps <br> within the <br> Range |
| :---: | :---: | :---: | :---: | :---: |
| 1 | 0 to 511 | 1 | 2 | 512 |
| 2 | 512 to 767 | 1 | 1 | 256 |
| 3 | 768 to 1024 | 2 | 1 | 256 |

The time required to go from $10 \%(102 / 1024)$ to $90 \%$ (922/1024) duty cycle can be calculated using the following equation:
$\mathrm{T}_{\mathrm{PWM}}=100 \mu \mathrm{~s}$ (with 10 kHz dimming frequency)
Cycle in Zone \#1 = (511 - Starting Duty Cycle) x [(Zone \#1 Step Interval) / (Zone \#1 Step Increment)]

Cycle in Zone \#2 = Total Steps in Zone \#2 x [(Zone \#2 Step Interval) / (Zone \#2 Step Increment)]

Cycle in Zone \#3 = (End Duty Cycle - 768) x [(Zone \#3 Step Interval) / (Zone \#3 Step Increment)]

In this case, the total cycle will be:

$$
\begin{aligned}
\text { Total cycle } & =2 \times(511-102)+1 \times 256+0.5 \times(922-768) \\
& =1151 \\
\text { Total Fading Time } & =\text { Total Cycle } \times T_{\text {PWM }} \\
& =1151 \times 100 \mu \mathrm{~s}=115.1 \mathrm{~ms}
\end{aligned}
$$

Table 3 - Fault Protection Descriptions

| Type of Fault | User Disable? | Fault Criteria | Action on Fault |  | Recovery |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Device | FLT pin (latching / non-latching | Condition(s) | $\overline{\text { FLT }}$ pin |
| Input <br> Under-voltage at VLDO | No | $\begin{gathered} \text { VLDO }<4.15 \mathrm{~V} \\ \quad \text { (rising) } \end{gathered}$ | No Startup | Not Active | $\begin{aligned} & \text { VLDO }>4.15 \mathrm{~V} \\ & \quad \text { (rising) } \end{aligned}$ | High |
|  | No | $\text { VLDO }<4.0 \mathrm{~V}$ <br> (falling) | Shutdown | Not Active | VLDO > 4.15V <br> (rising) | High |
| Input <br> Under-voltage at VCC | No | $\begin{gathered} \mathrm{VCC}<4.15 \mathrm{~V} \\ \quad \text { (rising) } \end{gathered}$ | No Startup | Not Active | $\begin{gathered} \text { VCC }>4.15 \mathrm{~V} \\ \quad \text { (rising) } \end{gathered}$ | High |
|  | No | $\begin{gathered} \mathrm{VCC}<4.0 \mathrm{~V} \\ \text { (falling) } \end{gathered}$ | Shutdown | Not Active | $\begin{gathered} \text { VCC }>4.15 \mathrm{~V} \\ (\text { rising }) \end{gathered}$ | High |
| Over-voltage Protection (OVP) | No | $\begin{gathered} \mathrm{V}_{\text {oup }}>1.23 \mathrm{~V} \\ \quad \text { (rising) } \end{gathered}$ | Regulate to OVP threshold: $\mathrm{I}_{\mathrm{O}(\mathrm{n})}=" \mathrm{on} "$ | Low (non-latching) | $\begin{gathered} \mathrm{V}_{\text {oup }}<1.22 \mathrm{~V} \\ \quad \text { (falling) } \end{gathered}$ | High on removal of fault condition |
| Over-current <br> Protection (OCP) | No | $\mathrm{V}_{\mathrm{cs}}>0.4 \mathrm{~V}$ | Limit Q1 FET drain current < 0.4V/R9 $(t y p)^{(1)}$ | High | $\mathrm{V}_{\mathrm{cs}}<0.4 \mathrm{~V}$ | High |
| Shorted LED(s) | Yes, tie SCP to VLDO | $\mathrm{V}_{\text {IO(n) }}>10 \times \mathrm{V}_{\text {SCP }}$ | Device on: $\begin{gathered} \mathrm{I}_{\mathrm{O}(\mathrm{n})}=\text { "off" } \\ \text { Other } \mathrm{I}_{\mathrm{O}(\mathrm{AlI})}=\text { "on" } \end{gathered}$ | Low (latching) | Replace Shorted LED(s) and Toggle EN or VCC | High |
|  |  | $\mathrm{V}_{\text {IO(All) }}>10 \times \mathrm{V}_{\text {SCP }}$ | Device latch-off; $\mathrm{I}_{\mathrm{OAIII}}=\text { "off" }$ | Low (latching) | Replace Shorted LED(s) and Toggle EN or VCC | High |
| $\begin{aligned} & \text { Open } \\ & \text { LED(s) } \end{aligned}$ | No | $\begin{aligned} & \mathrm{V}_{10(n)}<0.2 \mathrm{~V} \\ & \text { and OVP event } \end{aligned}$ | Device on: $\begin{gathered} \mathrm{I}_{\mathrm{O}(\mathrm{n})}=\text { "off" } \\ \text { Other } \mathrm{I}_{\mathrm{O}(\mathrm{AlI}}=\text { "on" } \end{gathered}$ | Low (latching) | Replace Open LED(s) and Toggle EN or VCC | High |
|  |  | $\mathrm{V}_{10(\mathrm{AlII})}<0.2 \mathrm{~V}$ and OVP event | Device latch-off; $\mathrm{l}_{\mathrm{OA} A 1)}=\text { "off" }$ | Low (latching) | Replace Open LED(s) and Toggle EN or VCC | High |
| Unused Strings | No | $\begin{gathered} \mathrm{V}_{\text {IOAII) }}<0.2 \mathrm{~V} \\ \text { (start up) } \end{gathered}$ | Device on: $\begin{gathered} \mathrm{I}_{\mathrm{O}(\mathrm{n})}=\text { "off" } \\ \text { Other } \mathrm{I}_{\mathrm{O}(\mathrm{AlI})}=\text { "on" } \end{gathered}$ | High |  |  |
| Over-Temperature Protection (OTP) | No | $\mathrm{T}_{\mathrm{j}}>150^{\circ} \mathrm{C}$ (typ) | Device off; $\mathrm{I}_{\mathrm{oA} \text { (AI) }}=\text { "off" }$ | Low (latching) | Satisfy $\mathrm{T}_{\text {HYS }}>10^{\circ} \mathrm{C}$; <br> Device On; $\mathrm{I}_{\mathrm{O} \text { (AIII }}=\text { "on"; }$ <br> Toggle EN, VCC | High |

## Components Selection (continued)

Time required to go from $10 \%(102 / 1024)$ to $90 \%$ (922/1024) duty cycle can be calculated using the following equation:
$\mathrm{T}_{\text {PWM }}=100 \mu \mathrm{~s}$ (PWM Dimming Period)
Total Cycle $=2 \times(511-102)+256+\frac{1}{2} \times(922-768)=1151$
Total Time $=1151 \times T_{\text {PWM }}=115.1 \mathrm{~ms}$

## Optional Synchronization to SYNC Input

The SC5012/Q provides an option to synchronize the LED dimming to an external clock source connected to the SYNC pin. In certain applications, it may be beneficial to synchronize the LED drive signal to the LCD screen refresh signals such as VSYNC or HSYNC. This helps reduce or eliminate some of the problems associated with using LED backlights, such as flickering, shimmering, etc.

The phase lock loop available on the SC5012/Q can be programmed via $I^{2} C$ to synchronize the internal 11 MHz oscillator to the SYNC input. Figures on page 9 show synchronization of SC5012/Q to a 21 kHz SYNC signal applied on SYNC pin. The turn-on of the LED string IO1 (falling edge of $\mathrm{V}_{101}$ ) is synchronized to the rising edge of the SYNC input. The turn-on of rest of the strings will be delayed based on the phase shifting algorithm.

## Fault Protection

The SC5012/Q provides fault detection for low supply voltage, LED related faults, boost converter over-voltage and thermal shutdown. The open drain output pin ( $\overline{\text { FLT }}$ ) indicates a system fault. The nature of the fault can be read from the fault status resistor (register address: $0 \times 00$ ) via $I^{2} \mathrm{C}$ interface. Refer to Table 3 for a description of the Fault Protection Modes.

## Other Possible Configurations

Depending on different application requirement, the SC5012/Q can also be easily configured to other topology such as SEPIC (Single-Ended Primary-Inductor Converter) configuration shown in Figure 3, page 27.

## High Output Voltage Configuration

If high output voltage application is required, an additional external cascode MOSFET can be added on each IO pin to meet such requirement, please refer to Figure 4 on page 27 for reference.

In this case, the upper limit on the output voltage is mainly determined by the rating of the external MOSFET, heat dissipation, etc.

## PCB Layout Considerations

The placements of the power components outside the SC5012/Q should follow the layout guidelines of a general boost converter. The Detailed Application Circuit is used as an example.

1. Capacitor (C20) should be placed as close as possible to the VCC pin and PGND to achieve the best performance. Place it next to the IC.
2. The decoupling capacitor (C17) for Pin VIN should return to AGND. Place it next to the IC.
3. Capacitor (C1) is the input power filtering capacitor for the boost. It needs to be tied to PGND.
4. The converter power train inductor (L1) is the boost converter input inductor. Use wide and short traces connecting these components.
5. The output rectifying diode (D1) uses a Schottky diode for fast reverse recovery. Transistor (Q1) is the external switch. Resistor ( R 9 ) is the switch current sensing resistor. To minimize switching noise for the boost converter, the output capacitor (C6) should be placed such that the loop formed by Q1, D1, C6 and R9, is minimized. The output of the boost converter is used to power up the LEDs. Use wide and short trace connecting Pin NDRV and the gate of Q1. The GNDs for R9 and C6 should be PGND. These components should be close to the SC5012/Q.
6. Resistor (R8) is the output current adjusting resistor for IO1 through IO4 and should return to AGND. Place it next to the IC.
7. Resistor (R6) is the switching frequency adjusting resistor and should return to AGND. Place it next to the IC.
8. The decoupling capacitor (C21) for Pin VLDO should return to AGND. Place it next to the IC.
9. Resistors ( $\mathrm{R} 4, \mathrm{R5}$ ) form a divider to set the SCP level, R4 should return to AGND. Place it next to the IC.
10. R11 and R10 form a divider to set the OVP level for VOUT, R10 should return to AGND. Place it next to the IC.

## Components Selection (continued)

11. All the traces for components with AGND connection should avoid being routed close to the noisy areas.
12. An exposed pad is located at the bottom of the SC5012/Q for heat dissipation and analog ground. A copper area underneath the pad is used for better heat dissipation. On the bottom layer of the PCB another copper area, connected through vias to the top layer, is used for better thermal performance. The pad at the bottom of the SC5012/Q should be connected to AGND. AGND should be connected to PGND at a single point for better noise immunity.

## Inductor Selection

The choice of the inductor affects the converter's steady state operation, transient response, and its loop stability. Special attention needs to be paid to three specifications of the inductor, its value, its DC resistance and saturation current. The inductor's inductance value also determines the inductor ripple current. The boost converter will operate in either CCM (Continuous Conduction Mode) or DCM (Discontinuous Conduction Mode) depending on its operating conditions. The inductor DC current or input current can be calculated using the following equation.

$$
\begin{aligned}
& \mathrm{I}_{\mathrm{IN}}=\frac{\mathrm{V}_{\text {OUT }} \times \mathrm{I}_{\text {OUT }}}{\mathrm{V}_{\text {IN }} \times \eta} \\
& \mathrm{I}_{\mathbb{I N}}-\text { Input current; } \mathrm{I}_{\text {OUT }}-\text { Output current; } \\
& \mathrm{V}_{\text {OUT }}-\text { Boost output voltage; } \\
& \mathrm{V}_{\mathbb{I N}}-\text { Input voltage; } \\
& \eta-\text { Efficiency of the boost converter. }
\end{aligned}
$$

Then the duty ratio under CCM is shown by the following equation.

$$
D=\frac{V_{\text {OUT }}-V_{\text {IN }}+V_{D}}{V_{\text {OUT }}+V_{D}}
$$

$\mathrm{V}_{\mathrm{D}}$ - Forward conduction drop of output rectifying diode
When the boost converter runs under DCM ( $\mathrm{L}<\mathrm{L}_{\text {boundary }}$ ), it takes the advantages of small inductance and quick transient response; where as if the boost converter works under CCM ( $\mathrm{L}>\mathrm{L}_{\text {boundary }}$ ), normally the converter has higher efficiency.

When selecting an inductor, another factor to consider is the peak-to-peak inductor current ripple, which is given by the following equation.

$$
\Delta \mathrm{I}_{\mathrm{L}}=\frac{\mathrm{V}_{\mathrm{IN}} \times \mathrm{D}}{\mathrm{f}_{\mathrm{SW}} \times \mathrm{L}}
$$

Usually this peak-to-peak inductor current ripple can be chosen between $30 \%$ to $50 \%$ of the maximum input DC current. This gives the best compromise between the inductor size and converter efficiency. The peak inductor current can be calculated using the following equation.

$$
I_{\text {L-peak }}=I_{I N}+\frac{V_{\mathbb{I N}} \times D}{2 x f_{S W} \times L}
$$

For most applications, an inductor with value of $2.2 \mu \mathrm{H}$ to $22 \mu \mathrm{H}$ should be acceptable, (refer to the detailed application circuit on page26, Figure 2). The inductor peak current must be less than its saturation rating. When the inductor current is close to the saturation level, its inductance can decrease $20 \%$ to $35 \%$ from the 0A value depending on the vendor specifications. Using a small value inductor forces the converter in DCM, in which case the inductor current ramps down to zero before the end of each switching cycle. It reduces the boost converter's maximum output current and produces larger input voltage ripple. The DCR of the inductor plays a significant role for the total system efficiency and usually there is a trade-off between the DCR and size of the inductor. Table 4 lists some recommended inductors and their vendors.

Table 4. Recommended Inductors

| Inductor | Website |
| :--- | :--- |
| HCM0703, 2.2uH~10uH | www.cooperindustries.com |
| IHLP-2525CZ-01, 4.7UH $\sim 10 u H$ | www.vishay.com |
| MLPC0730L, 2.2uH~4.7uH | www.nec-tokin.com/english |

## Output Capacitor Selection

The next design task is targeting the proper amount of output ripple voltage due to the constant-current LED loads. Usually X5R or X7R ceramic capacitor is recommended. The ceramic capacitor minimum capacitance needed for a given ripple can be estimated using the following equation.

## Components Selection (continued)

$$
\begin{aligned}
& C_{\text {OUT }}=\frac{\left(V_{\text {OUT }}-V_{\text {IN }}\right) \times I_{\text {OUT }}}{V_{\text {OUT }} \times f_{\text {SW }} \times V_{\text {RIPPLE }}} \\
& V_{\text {RIPPLE }}-\text { Peak to peak output ripple. }
\end{aligned}
$$

The ripple voltage should be less than 200 mV (pk-pk) to ensure good LED current sink regulation. For example, a typical application where $150 \mathrm{~mA} /$ channel current is needed, the total output current for 4 channels will be 600 mA , and $3 \mathrm{x} 10 \mu \mathrm{~F}$ or $6 \mathrm{x} 4.7 \mu \mathrm{~F}$ capacitors are recommended.

During load transient, the output capacitor supplies or absorbs additional current before the inductor current reaches its steady state value. Larger capacitance helps with the overshoot/undershoots during load transient and loop stability. Recommended ceramic capacitor manufacturers are listed in Table 5.

Table 5. Recommended Ceramic Capacitor Vendors

| Vendor | Website |
| :---: | :---: |
| kemet | www.kemet.com |
| Vishay | www.vishay.com |
| TDK | www.tdk.com |
| Murata | www.murata.com |
| Taiyo Yuden | www.t-yuden.com |

## Input Capacitor Selection

X5R or X7R ceramic capacitor is recommended for input bypass capacitor. A $2.2 \mu \mathrm{~F}$ capacitor is sufficient for the VCC input. Bypass the VIN input with a $10 \mu \mathrm{~F}$ or larger ceramic capacitor.

## Output Freewheeling Diode Selection

Schottky diodes are the ideal choice for SC5012/Q due to their low forward voltage drop and fast switching speed. Table 6 shows several different Schottky diodes that work properly with the SC5012/Q. Verify that the diode has a voltage rating greater than the maximum possible output voltage. The diode conducts current only when the power switch is turned off. The diode must be rated to handle the average output current. A diode rated for 1A average current will be sufficient for most designs.

Table 6. Recommended Rectifier Diodes

| Rectifier Diode | Vendor Website |
| :---: | :---: |
| DFLS140 | www.diodes.com |
| SS14/15/16, SS24/25/26 | www.vishay.com |

## External Power MOSFET Selection

The boost converter in SC5012/Q uses an external power MOSFET to regulate the output voltage and output power to drive LED loads. This boost switching structure has an advantage in that the SC5012/Q is not exposed to high voltage. Only the external power MOSFET, freewheeling diode and the inductor will be exposed to the output voltage. The external power MOSFET should be selected with its voltage rating higher than the output voltage by minimum $30 \%$. The current rating should be enough to handle the inductor peak current. Low $\mathrm{R}_{\mathrm{DS}}(\mathrm{On})$ MOSFETs are preferred for achieving better efficiency.

The GD (gate driver) on SC5012/Q provides 1.5A (peak) current driving capability which is suitable for most MOSFETs for high frequency operation. The average current required to drive the mosfet is given by the following equation.

$$
\begin{aligned}
& I_{G A T E}=Q_{G} \times f_{S W} \\
& Q_{G}-\text { Gate charge }
\end{aligned}
$$

The $R_{\text {DS(ON) }}$ and its RMS current $I_{\text {S_RMS }}$ of the power MOSFET will generate the conduction loss using the following equation.

$$
P_{\text {COND }}=I_{\text {S_RMs }}{ }^{2} \times R_{\text {DS(on) }}
$$

The MOSFET's switch loss can be calculated using the following equation.

$$
P_{\text {SW }}=1 / 2 \times V_{\text {IN }} \times I_{\text {L_PEAK }} \times f_{\text {SW }} \times\left(T_{\text {ON }}+T_{\text {OFF }}\right)
$$

Where $T_{\text {ON }}$ and $T_{\text {OFF }}$ are the MOSFET's on and off time and they can be estimated by the following equations.

$$
\mathrm{T}_{\mathrm{ON}}=\mathrm{t}_{\mathrm{r}}+\frac{\mathrm{Q}_{\mathrm{gd}}}{\left(5-\mathrm{V}_{\text {plateau }}\right) /\left(5+\mathrm{R}_{\mathrm{g}}\right)}
$$

## Components Selection (continued)

$$
\mathrm{T}_{\text {OFF }}=\mathrm{t}_{\mathrm{f}}+\frac{\mathrm{Q}_{\mathrm{gd}}}{V_{\text {plateau }} /\left(5+R_{\mathrm{g}}\right)}
$$

Where $t_{r} t_{f} Q_{g d}$ and $V_{\text {plateau }}$ can usually be found from datasheet of the selected MOSFET. $R_{g}$ is the resistance of the optional resistor connected in serial on the gate of the MOSFET.

## Current Sensing Resistor Selection

The switch current is sensed via the current sensing resistor, $\mathrm{R}_{\mathrm{cs}}$. The sensed voltage at this pin is used to set the peak switch current limit and also used for steady state regulation of the inductor current. The current limit comparator has a trip voltage of 0.4 V . $\mathrm{R}_{\mathrm{cs}}$ value is chosen to set the peak inductor and switch current using the following equation.

$$
I_{\mathrm{sw}(\text { Peak })}=0.4 / \mathrm{R}_{\mathrm{Cs}}
$$

The power dissipation in $\mathrm{R}_{\mathrm{CS}}$ can be calculated using the following equations.

$$
\begin{aligned}
& P_{R_{-} C S}=I_{\text {RMS }}{ }^{2} \times R_{C S} \\
& I_{\text {RMS }}=D \times\left[I_{O} /(1-D)\right]^{2} \\
& I_{O}=\text { Output DC Current, } D=\text { Duty Cycle }
\end{aligned}
$$

For the typical application circuit shown in the detailed application drawing(page26, Figure 2), the power dissipation on the sensing resistor is shown by the following equation.

Assuming $\mathrm{V}_{\text {IN }}=12 \mathrm{~V}$ and $\mathrm{V}_{\text {out }}=33 \mathrm{~V}$, thus $\mathrm{D}=63.6 \%$,

$$
\begin{aligned}
& \mathrm{I}_{\mathrm{RMS}}=0.636 \times[0.6 / 0.364]^{2}=1.728(\mathrm{~A}) \\
& \mathrm{P}_{\mathrm{R}_{\mathrm{Z}} \mathrm{CS}}=1.728^{2} \times 0.11=0.328(\mathrm{~W})
\end{aligned}
$$

For this example, a $0.11 \Omega 1 \%$ thick-film chip resistor rated at 1 W can be used.

## PLL Filter Component Selection

The Application Circuit shows the optimal R/C filter components for the PLL compensation. These are optimized for internal 1 MHz switching frequency. Please contact

Semtech application group if a different frequency is needed in a different system.


Figure 2—Application Circuit Example, 40 LED @ 150mA


Figure 3- SEPIC Configuration


Figure 4-Cascode Configuration drives 80LEDs

## Serial Interface

## The I ${ }^{2} \mathrm{C}$ General Specification

The SC5012/Q is a read-write slave-mode $I^{2} C$ device and complies with the Philips $I^{2} \mathrm{C}$ standard Version 2.1, dated January 2000. The SC5012/Q has 11 user-accessible internal 8 -bit registers. The $I^{2} \mathrm{C}$ interface has been designed for program flexibility, supporting direct format for write operation. Read operations are supported on both combined format and stop separated format. While there is no auto increment/decrement capability in the SC5012/Q $1^{2} \mathrm{C}$ logic, a tight software loop can be designed to randomly access the next register independent of which register you begin accessing. The start and stop commands frame the data-packet and the repeat start condition is allowed if necessary.

## Limitations to the I ${ }^{2} \mathrm{C}$ Specifications

The SC5012/Q only recognizes seven bit addressing. This means that ten bit addressing and CBUS communication are not compatible. The device can operate in either standard mode (100kbit/s) or fast mode (400kbit/s).

## Slave Address Assignment

The 7-bit slave address is 0101 111x. The eighth bit is the data direction bit. $0 \times 5 \mathrm{~F}$ is used for read operation and $0 \times 5 \mathrm{E}$ is used for write operation.

## Supported Formats

The supported formats are described in the following subsections.

## (1) Direct Format - Write

The simplest format for an $I^{2} \mathrm{C}$ write is direct format. After the start condition $[\mathrm{S}]$, the slave address is sent, followed by an eighth bit indicating a write. The SC5012/Q $I^{2} \mathrm{C}$ then acknowledges that it is being addressed, and the master responds with an 8 bit data byte consisting of the register address. The slave acknowledges and the master sends the appropriate 8 bit data byte. Once again, the slave acknowledges and the master terminates the transfer with the stop condition [P].

## (2) Combined Format - Read

After the start condition [S], the slave address is sent, followed by an eighth bit indicating a write. The SC5012/Q $I^{2} C$ then acknowledges that it is being addressed, and the master responds with an 8 bit data byte consisting of the
register address. The slave acknowledges and the master sends the repeated start condition [Sr]. Once again, the slave address is sent, followed by an eighth bit indicating a read. The slave responds with an acknowledge and the 8 bit data from the previously addressed register; the master then sends a non-acknowledge (NACK). Finally, the master terminates the transfer with the stop condition [P].

## (3) Stop Separated Reads

Stop-separated reads can also be used. This format allows a master to set up the register address pointer for a read and return to that slave at a later time to read the data. In this format the slave address followed by a write command are sent after a start [S] condition. The SC5012/Q then acknowledges it is being addressed, and the master responds with the 8 -bit register address. The master sends a stop or restart condition and may then address another slave. After performing other tasks, the master can send a start or restart condition to the SC5012/Q with a read command. The device acknowledges this request and returns the data from the register location that had previously been set up.

## Serial Interface (continued)

## $I^{2}$ C Direct Format Write

| S | Slave Address | W | A | Register Address | A | Data | A | P |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |

S - Start Condition
$\mathrm{W}-\mathrm{W}$ rite $={ }^{\prime} 0$ '
Slave Address - 7-bit
A - Acknowledge (sent by slave)
P-Stop condition

Register address - 8-bit
Data - 8-bit

## $I^{2}$ C Stop Separated Format Read

| Register Address Setup Access |  |  |  |  |  |  |  |  | Master Addresses other Slaves | Register Read Access |  |  |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| S |  | Slave Address | W | A | Register Address | A | P | S | Slave Address B | $\mathrm{S} / \mathrm{Sr}$ | Slave Address | R | A | Data | NACK | P |
|  |  |  |  |  |  |  |  |  |  |  |  |  |  |  |  |  |

S - Start Condition
Slave Address - 7-bit
$\mathrm{W}-\mathrm{Write}=$ ' 0 '
Register address - 8-bit
R - Read = ' 1 '
A - Acknowledge (sent by slave)
NAK - Non-Acknowledge (sent by master)
Sr - Repeated Start condition
P - Stop condition

## $I^{2} \mathrm{C}$ Combined Format Read

| S | Slave Address | W | A | Register Address | A | Sr | Slave Address | R | A | Data | NACK | P |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- |

Slave Address - 7-bit
Register address - 8-bit
Data-8-bit

S - Start Condition
W - Write = ' 0 '
$R-$ Read $=$ ' 1 '
A - Acknowledge (sent by slave)
NAK - Non-Acknowledge (sent by master)
Sr - Repeated Start condition
P - Stop condition

## Register Map

| Address | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | Reset Value | Name |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 0x00 | FSYNC_ <br> GD | PLL_RDY | $\begin{aligned} & \text { LED_- } \\ & \text { SHORT } \end{aligned}$ | $\begin{aligned} & \text { LED_- } \\ & \text { OPEN } \end{aligned}$ | SYNC GD | OTP | OVP | FAULT/ CLF | 0x00 | Fault Status |
| $0 \times 01$ | WND1 | WND0 | $\begin{aligned} & \text { FAST_- } \\ & \text { FREQ } \end{aligned}$ | FLT_EN | SYNC_EN | PHASE SHIFT | $\begin{aligned} & \text { INT_ } \\ & \text { DUTY } \end{aligned}$ | INT_ PWM | 0xB5 | Device Control |
| $0 \times 02$ | IDAC7 | IDAC6 | IDAC5 | IDAC4 | IDAC3 | IDAC2 | IDAC1 | IDAC0 | 0x1F | Analog Dimming Control |
| $0 \times 03$ | - | - | - | - | - | - | D9 | D8 | 0x00 | Dimming Duty Cycle Control 1 |
| 0x04 | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 | 0x00 | Dimming Duty Cycle Control 2 |
| 0x05 | FREQ7 | FREQ6 | FREQ5 | FREQ4 | FREQ3 | FREQ2 | FREQ1 | FREQ0 | 0x00 | Dimming Frequency Select |
| $0 \times 06$ | - | - | - | - | - | - | NPLL17 | NPLL16 | $0 \times 00$ | PLL Divider MSB |
| $0 \times 07$ | NPLL15 | NPLL14 | NPLL13 | NPLL12 | NPLL11 | NPLL10 | NPLL9 | NPLL8 | 0x00 | PLL Divider LSB2 |
| 0x08 | NPLL7 | NPLL6 | NPLL5 | NPLL4 | NPLL3 | NPLL2 | NPLL1 | NPLLO | 0x08 | PLL Divider LSB1 |
| 0x09 | FADE_EN | FADE TYPE | - | - | - | STEP_ <br> MUL2 | STEP_ <br> MUL1 | STEP_ <br> MULO | 0x80 | Fade Options |
| 0x0A | ARESYNC <br> _EN | FADE RATE6 | FADE RATE5 | FADE RATE4 | FADE_ RATE3 | FADE_ RATE2 | FADE_ RATE1 | FADE RATEO | 0x00 | Fade Rate |

## Definition of Registers and Bits

Fault Status Register
This register monitors various fault conditions.

| Bit Field | Definition | Read / Write | Description |
| :--- | :---: | :---: | :--- |
| $0 \times 00[7]$ | FSYNC_GD | $R$ | FSYNC status. ( $1=$ FSYNC input is detected, $0=$ no FSYNC signal detected) |
| $0 \times 00[6]$ | PLL_RDY | $R$ | PLL ready status |
| $0 \times 00[5]$ | LED_SHORT | $R$ | One or more LED strings faulted shorted |
| $0 \times 00[4]$ | LED_OPEN | $R$ | One or more LED strings faulted open |
| $0 \times 00[3]$ | SYNC_GD | $R$ | SYNC good signal. ( $1=$ sync input is detected, $0=$ no SYNC signal detected $)$ |
| $0 \times 00[2]$ | OTP | $R$ | Thermal shutdown ( $1=$ thermal OTP fault) |
| $0 \times 00[1]$ | OVP | $R$ | Output over-voltage fault ( $1=$ OVP ) |
| $0 \times 00[0]$ | FAULT/CLF | $R$ | OR of all fault conditions ( $0=$ no fault, $1=$ fault condition) |

## Definition of Registers and Bits (continued)

## Device Control Register

This register provides different control features of the device.

| Bit Field | Definition | Read / Write | Description |
| :---: | :---: | :---: | :---: |
| 0x01 [7:6] | WIN[1:0] | R/W | A modified duty cycle sent into the PWMI pin replaces the existing saved duty cycle when its deviation from the saved duty is outside the window for two consecutive samples. <br> $00=0$ bits (no window) <br> $01= \pm 1$ bit window <br> $10= \pm 2$ bit window <br> $11= \pm 3$ bit window |
| 0x01 [5] | FAST_FREQ | R/W | Determines the LED PWM dimming frequency selection: <br> 1 = High PWM dimming frequency mode assuming 9-bit dimming duty cycle register D[8:0], dividing the system clock 11 MHz / ( $512 \times$ (FREQ+1)). <br> $0=$ Low PWM dimming frequency mode assuming 10-bit dimming duty cycle register D[9:0]; dividing the system clock 11 MHz / ( $1024 \times$ (FREQ+1)). |
| 0x01 [4] | FLT_EN | R/W | This bit enables fault checking: $0=$ LED_OPEN and LED_SHORT faults are not checked. 1 = LED_OPEN and LED_SHORT faults are checked. |
| 0x01 [3] | SYNC_EN | R/W | Enables video signal synchronization with the PLL: $0=$ SYNC is disabled. <br> 1 = PLL tracks the VSYNC input signal. |
| 0x01 [2] | PHASE_SHIFT | R/W | Enables String-by-String phase shifting. This is a don't care if INT_PWM $=0$. <br> $0=$ Phase shifting disabled. <br> 1 = Phase shifting is enabled |
| 0x01 [1] | INT_DUTY | R/W | Determines the duty cycle source. This is a don't care if INT_PWM $=0$. <br> $0=$ LED duty cycle is set by the PWMI input <br> 1 = LED duty cycle is set by the 10-bit duty cycle control registers |
| 0x01 [0] | INT_PWM | R/W | Sets the LED PWM dimming source. <br> $0=$ PWM driven directly from the PWMI input source (direct PWM dimming) <br> 1 = PWM driven from an internal oscillator (required for phase-shifted PWM dimming); enables the PLL. |

## Analog Dimming Control Register

This register is used to program the LED string current through the on-chip 8-bit DAC.

| Bit Field | Definition | Read / Write | Description |
| :---: | :---: | :---: | :--- |
| $0 \times 02[7: 0]$ | IDAC [7:0] | R / W | 8 -bit analog dimming register - The LED current can adjusted in $256\left(=2^{8}\right)$ steps from 0 mA to <br> max value determined by $\mathrm{R}_{\text {IETT }}$ |

## Definition of Registers and Bits (continued)

## Dimming Duty Cycle Control Register

These two registers ( $0 \times 03$ and $0 \times 04$ ) combine together as a 10-bit register for controlling the PWM dimming duty cycle.

| Bit Field | Definition | Read / Write | Description |
| :---: | :---: | :---: | :--- |
| $0 \times 03[1: 0]$ <br> $0 \times 04[7: 0]$ | $\mathrm{D}[9: 0]$ | R/W | 10-bit PWM brightness setting - This value is spread over registers: $0 \times 03$ (MSB) and $0 \times 04$ <br> (LSB). The LED PWM dimming duty cycle can be evenly adjusted by the 10-bit register from 0 <br> to $100 \%$ with D[9:0] value changes from 0 to $0 \times 3 F$. |

## Dimming Frequency Select Register

This register is used to program the LED PWM dimming frequency.

| Bit Field | Definition | Read / Write | Description |
| :---: | :---: | :---: | :--- |
| $0 \times 05[7: 0]$ | FREQ $[7: 0]$ | R/W | This register sets the LED dimming frequency. <br> FAST_FREQ $=1$, then LED dimming frequency is equal to $11 \mathrm{MHz} /(512 \times($ (FREQ+1)) <br> FAST_FREQ $=0$, then LED dimming frequency is equal to $11 \mathrm{MHz} /(1024 \times($ FREQ+1)) |

## PLL Control Registers

This register is used to set the PLL divider value.

| Bit Field | Definition | Read / Write | Description |
| :---: | :---: | :---: | :--- |
| $0 \times 06[1: 0]$ <br> $0 \times 07[7: 0]$ <br> $0 \times 08[7: 0]$ | NPLL [17:0] | R/W | These registers set the PLL divider value - The system clock is intended to run at 11 MHz <br> this value divides the system clock down to a frequency comparable to the VSYNC signal's <br> frequency to allow PLL synchronization. Typical values are shown below. |


| $\mathrm{F}_{\mathrm{IN}}$ | PLL Divider $\mathbf{N}$ | Register Values | $\mathrm{FPLL}=(\mathrm{N}+2) \times \mathrm{F}_{\mathrm{IN}}$ |
| :---: | :---: | :---: | :---: |
| 1 MHz | 8 | $0 \times 00-0 \times 00-0 \times 08$ | 11 MHz |

## Definition of Registers and Bits (continued)

Fade Options Registers
This register is used to select the fade in and fade out related features.

| Bit Field | Definition | Read / Write | Description |
| :---: | :---: | :---: | :---: |
| 0x09 [7] | FADE_EN | R/W | Enables the fading feature. <br> FADE_EN = 0: No Fading; Jumps directly to new PWM value. <br> FADE_EN = 1: Enables fading. |
| 0x09 [6] | FADE_TYPE | R/W | Selects the fading type. <br> FADE_TYPE = 0: Logarithmic Fading <br> FADE_TYPE = 1: Linear Fading |
| 0x09 [2:0] | STEP_MUL <br> [2:0] | R/W | Used to speed up fade time, when selected LED PWM dimming frequency is low. Define a $2^{N}$ multiplier of the fade amount. $\begin{aligned} & \text { STEP_MUL[2:0] }=000, N=0, \text { multiplier }=1 \\ & \text { STEP_MUL[2:0] }=001, N=1, \text { multiplier }=2^{1}=2 \\ & \text { STEP_MUL[2:0] }=010, N=2, \text { multiplier }=2^{2}=4 \\ & \text { STEP_MUL[2:0] }=011, N=3, \text { multiplier }=2^{3}=8 \\ & \text { STEP_MUL[2:0] }=100, N=4, \text { multiplier }=2^{4}=16 \\ & \text { STEP_MUL[2:0] }=101 \sim 111, N=5, \text { multiplier }=2^{5}=32 \end{aligned}$ |

## Fade Rate Register

This register is used to program the rate of the duty cycle change during the fade in and fade out operation.

| Bit Field | Definition | Read / Write | Description |
| :---: | :---: | :---: | :--- |
| $0 \times 0$ A [7] | ARBSSYNC_ <br> EN | R/W | Auto-resync enable bit. Synchronization of the PWM output to VSync is only enabled <br> when VSYNC EN $=1$ |
| $0 \times 0 A[6: 0]$ | FADE_RATE <br> $[6: 0]$ | R/W | Defines how often the duty is changed during a fade. <br> Fade rate $=$ PWM Output Rate $/(1+$ FADE_RATE[6:0] $)$ |



1. CONTROLLING DIMENSIONS ARE IN MILLIMETERS (ANGLES IN DEGREES).
2. COPLANARITY APPLIES TO THE EXPOSED PAD AS WELL AS THE TERMINALS.

## Land Pattern - MLPQ 4mm X 4mm, 24 Lead, EP 2.70mm X 2.70mm



| DIMENSIONS |  |  |
| :---: | :---: | :---: |
| DIM | INCHES | MILLIMETERS |
| C | $(.156)$ | $(3.95)$ |
| G | .122 | 3.10 |
| H | .106 | 2.70 |
| K | .106 | 2.70 |
| P | .020 | 0.50 |
| X | .010 | 0.25 |
| Y | .033 | 0.85 |
| Z | .189 | 4.80 |

1. CONTROLLING DIMENSIONS ARE IN MILLIMETERS (ANGLES IN DEGREES).
2. THIS LAND PATTERN IS FOR REFERENCE PURPOSES ONLY. CONSULT YOUR MANUFACTURING GROUP TO ENSURE YOUR COMPANY'S MANUFACTURING GUIDELINES ARE MET.
3. THERMAL VIAS IN THE LAND PATTERN OF THE EXPOSED PAD SHALL BE CONNECTED TO A SYSTEM GROUND PLANE. FAILURE TO DO SO MAY COMPROMISE THE THERMAL AND/OR FUNCTIONAL PERFORMANCE OF THE DEVICE.

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